

## Evaluation of High Temperature Components for Use in Geothermal Tools

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**Sandia National Laboratories**

EGS: High Temp Tools, Drilling Systems

## Project Objective

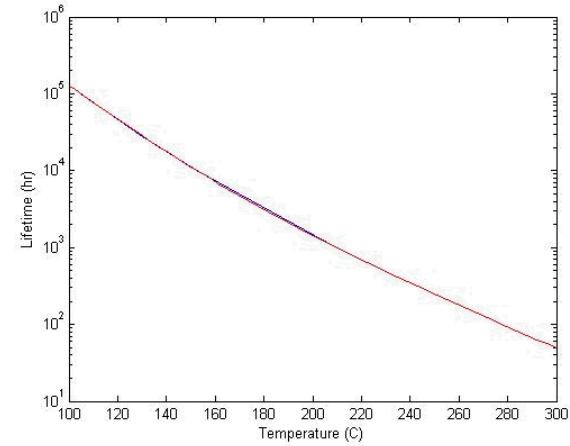
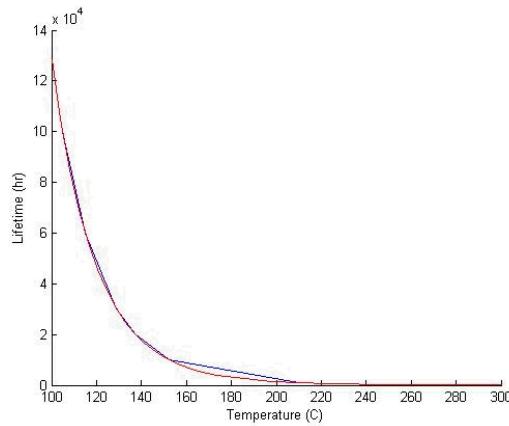
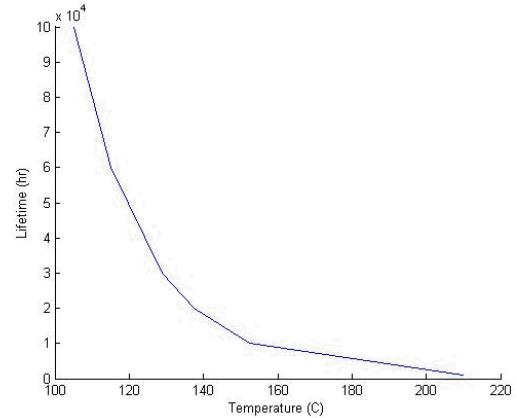
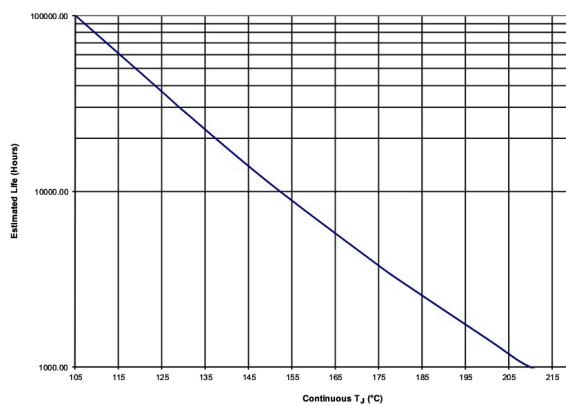
- Assist global geothermal tool development through independent high temperature component evaluation.
  - New HT component developers benefit from 3<sup>rd</sup> party evaluation of functionality and lifetime at temperature.
- Address the scarcity of COTS components rated for geothermal temperatures.
  - Public dissemination of beyond spec performance evaluations of select commercial components.
  - Helps developers who do not have the resources to dedicate to out-of-spec performance evaluation of expensive components.

- Component Selection
  - Open advertisement (FedBizOps) directed at HT component developers for 3<sup>rd</sup> party evaluation
  - Discussion with various end users and HT tool developers.
- Test Procedure Design (Unique for each component)
  - Internal discussions and communications with part developers
  - Once desired data is decided upon, test protocol is developed.
  - Where possible, equipment and processes are designed to enable future component tests

- Reporting
  - COTS component evaluations are made public through publication and/or presentation at relevant conferences
  - Prototype component evaluations are shared and discussed with the developers. Public dissemination strategies vary.

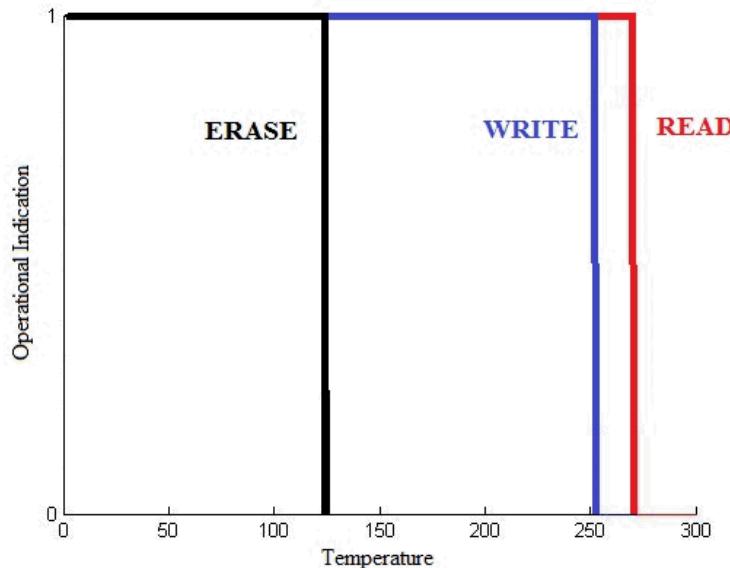
## Texas Instruments HT Flash Memory

“The predicted operating lifetime vs. junction temperature is based on reliability modeling and available qualification data.”

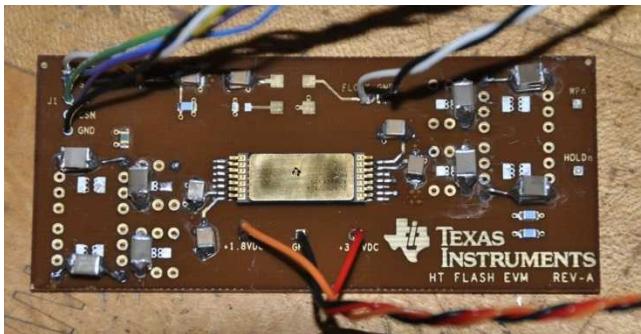


MATLAB Fit and Extrapolation

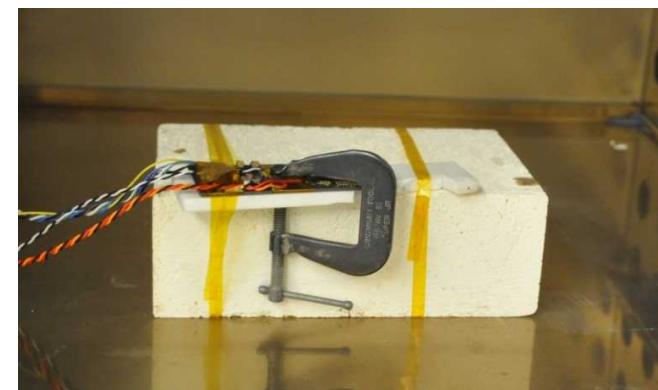
## HT Flash Memory



- Verified Read/Write functionality for 1000hr test @ 225° C
- 1000hr test at 240° on-going
- Determined maximum temperatures for individual functions
- Chip can recover functionality after short exposures to 300° C



Modification for 300C exposure

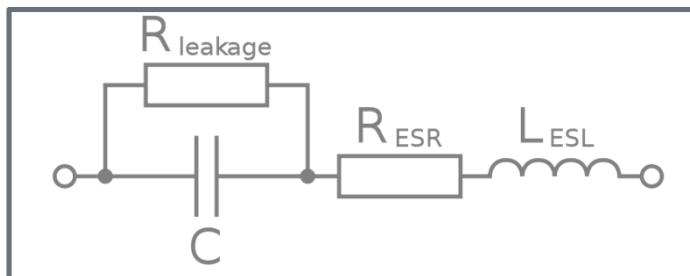


Mechanically secured

## Capacitor Testing



Ideal Capacitor



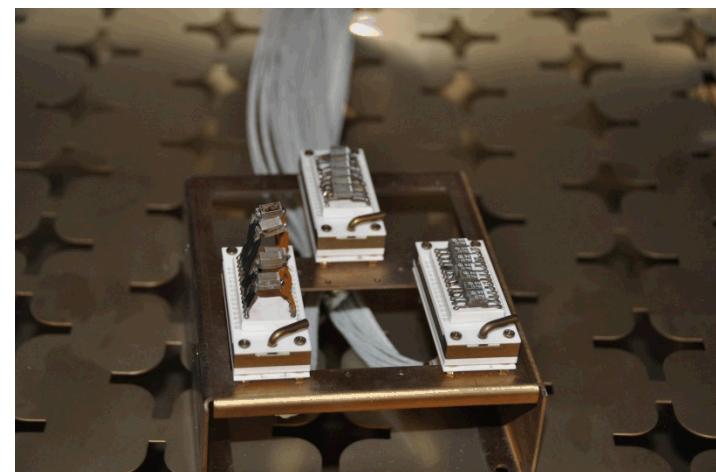
Real Capacitor

$$|Z| = \sqrt{ESR^2 + \left(\frac{1}{2\pi f C}\right)^2} \quad \theta = \tan^{-1}\left(\frac{(1/2\pi f C)}{ESR}\right)$$

$$C = \frac{1}{2\pi f |Z| \sin \theta}$$

$$ESR = |Z| \cos \theta$$

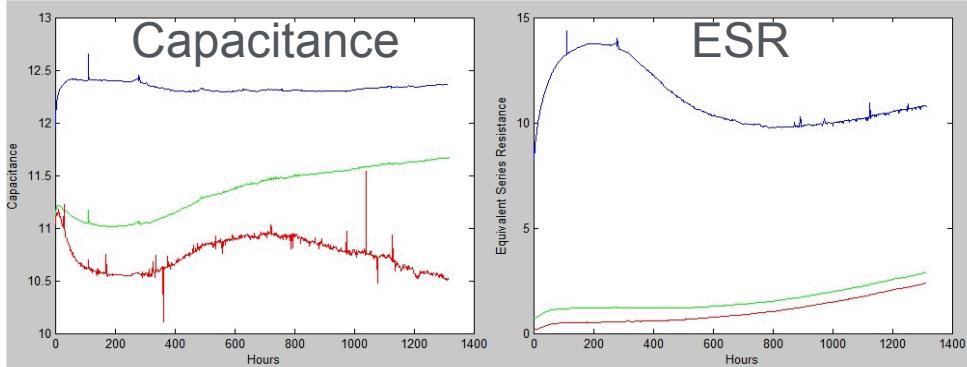
- Ceramic ZIF sockets for simultaneous HT evaluation of commercial capacitors
- Switch matrix enables multiple parallel tests using a single LCR/ESR Meter
- MatLab Control Interface



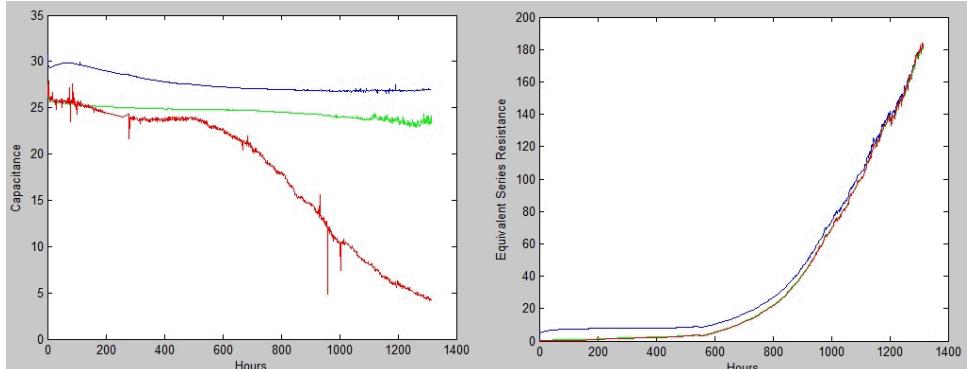
## COTS Solid Tantalum Capacitor Testing (1000hrs @ 260° C)

**Blue – 100Hz**  
**Green – 1kHz**  
**Red – 10kHz**

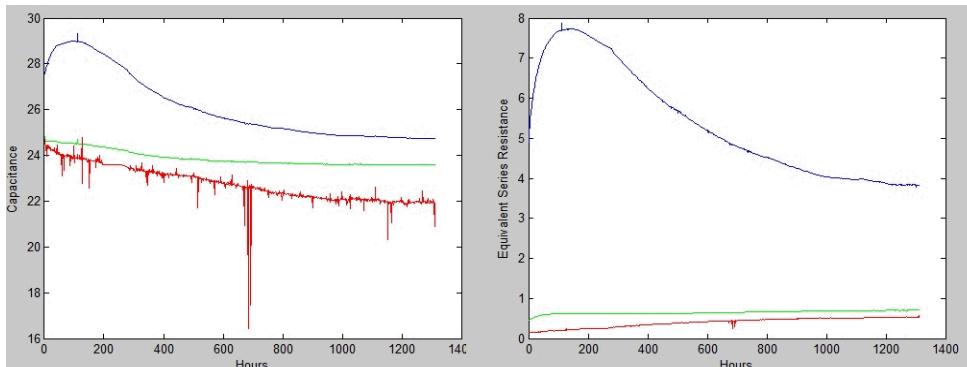
Vishay  
Capacitor



Kemet  
Capacitor



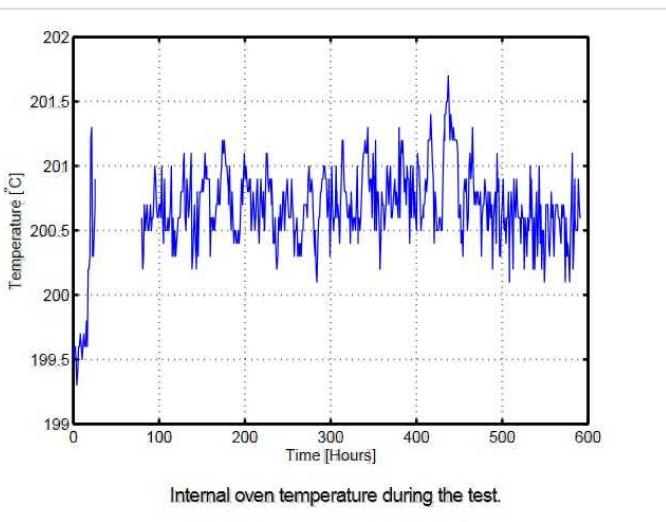
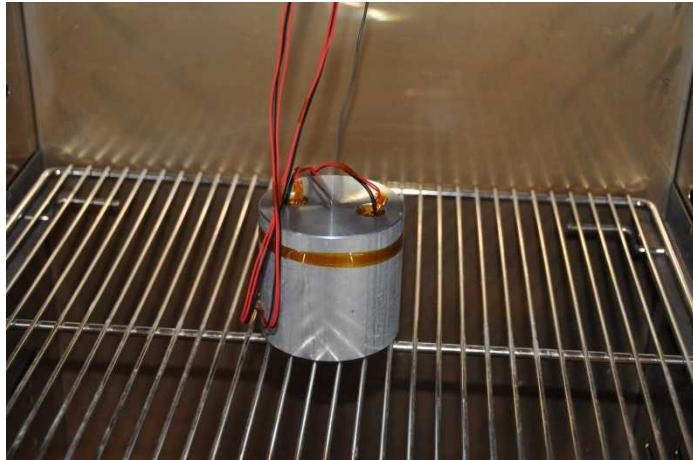
AVX  
Capacitor



- All caps are evaluated beyond temperature spec
- ESR and Capacitance lifetime performances vary with excitation frequency

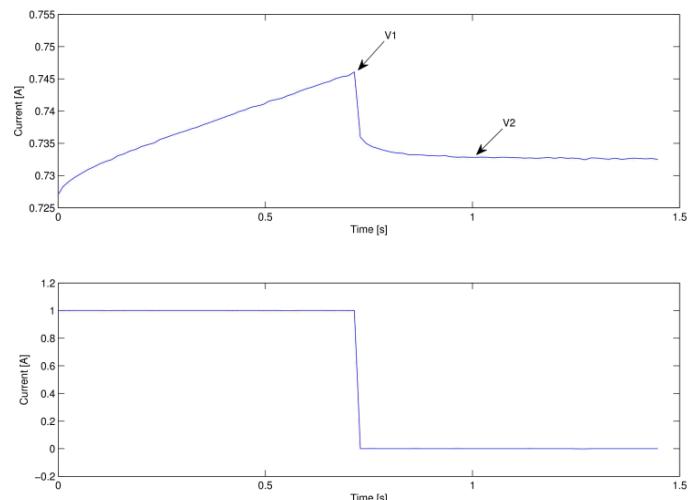
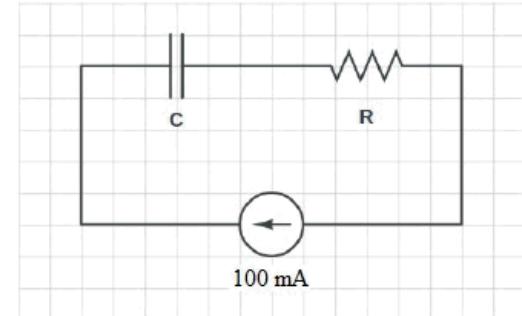


## Novel HT Ultracapacitor Test (500hr @ 200° C)



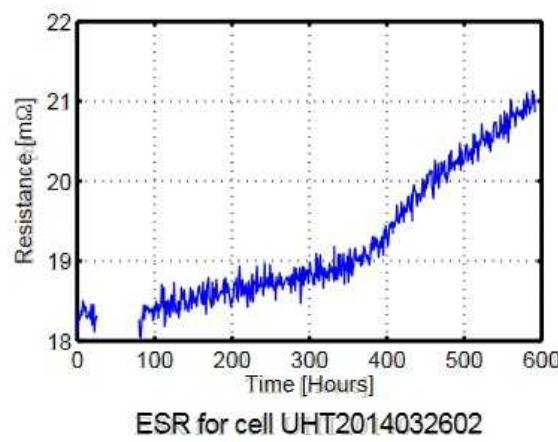
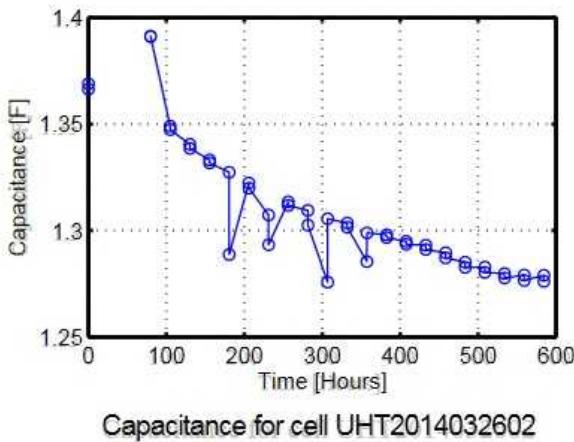
$$ESR = \frac{\Delta V}{I} = \frac{V_1 - V_2}{0.1A}$$

$$C = \frac{2 * E}{V^2}$$



Example data from a commercial capacitor

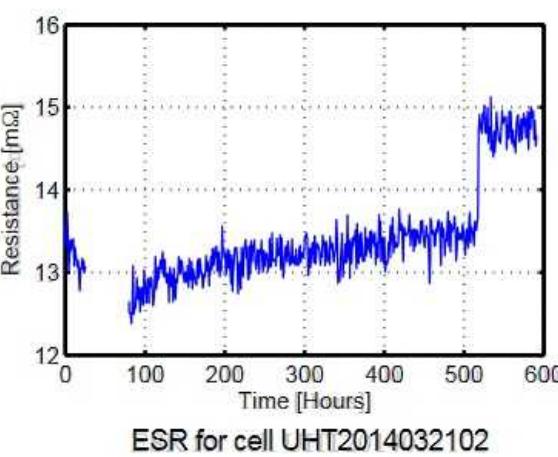
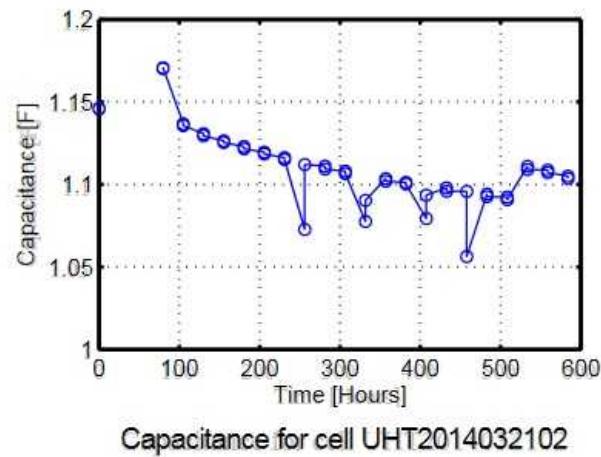
## FastCAP Results



### Cell 1

Initial Capacitance: 1.368F  
Final Capacitance: 1.278F  
% Cap Change: -6.56%

Initial ESR: 18.1mΩ  
Final ESR: 20.86mΩ  
% ESR Change: +15.23%

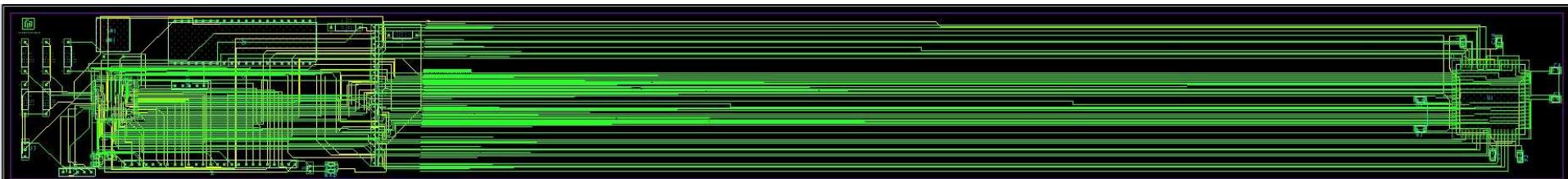
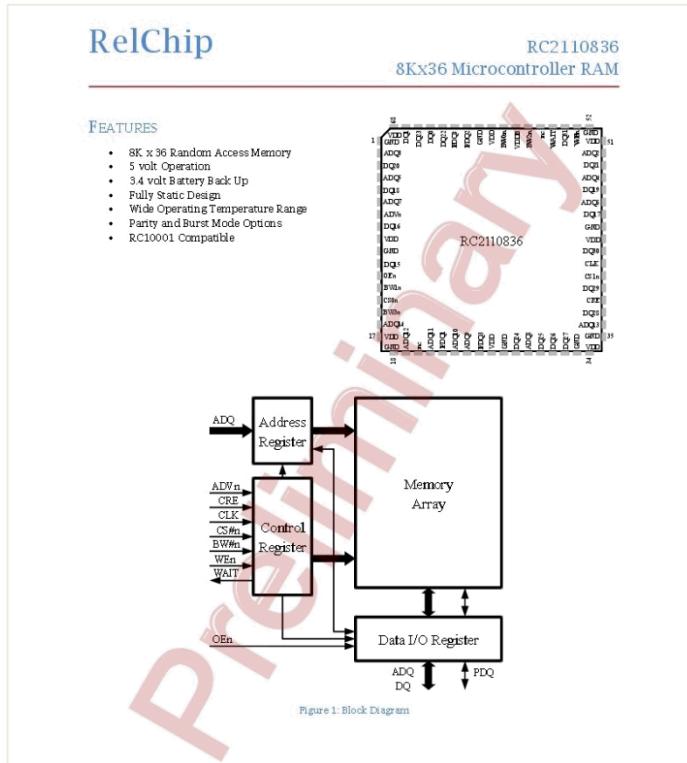


### Cell 2

Initial Capacitance: 1.146F  
Final Capacitance: 1.104F  
% Cap Change: -3.63%

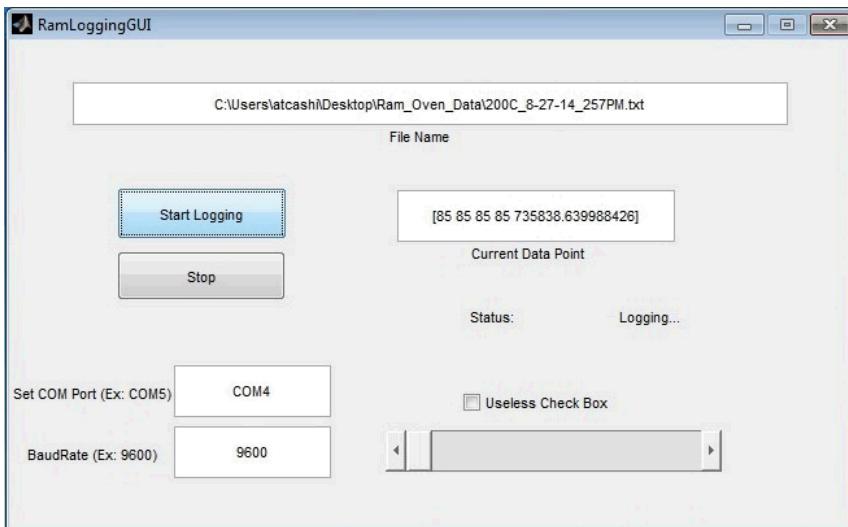
Initial ESR: 13.57mΩ  
Final ESR: 14.66mΩ  
% ESR Change: +8.02%

## HT-RAM Testing



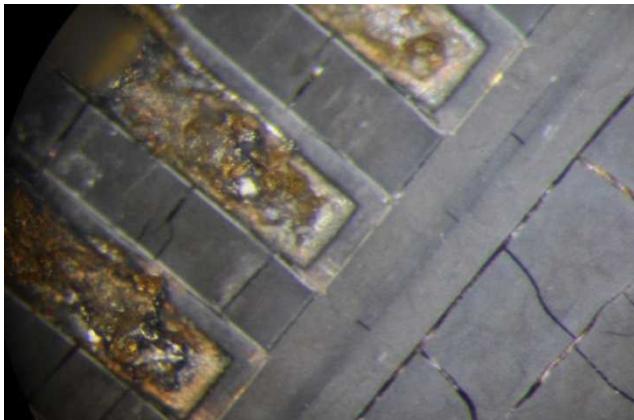
## HT-RAM

- Tests on-going
- Initially, the test PCB failed before the RAM at 280° C
- Reconfiguration in process



## ReIChip PCB Failure

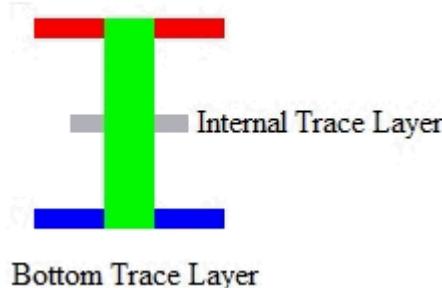
Damaged Solder Joints



Delaminated and shorted traces



Top Trace Layer



New PCBs have been developed with:

- Matched thermal expansion rates between copper and substrate
- Trace work routed on internal layers

# Accomplishments, Results and Progress

Original Planned Milestone/ Technical Accomplishment	Actual Milestone/Technical Accomplishment	Date Completed
FY(14) Issue a solicitation for Sandia HT Evaluation program	FedBizOps Solicitation Issued	2014
FY(14) Perform and make public a performance evaluation of a component deemed to have high potential value to geothermal tool designers.	Worked with FastCAP Systems to perform 3 <sup>rd</sup> party verification. Results published/presented by FastCAP at GRC 2014.	2014
FY(15) Perform and make public performance evaluations of 4 components with a stretch goal of a 5 <sup>th</sup> component.	3 types of COTS capacitors and a COTS Flash module have been evaluated and are scheduled for conference presentation.	04/2015
FY(15) Issue another open solicitation and communicate with component developers that are interested in the program.	Two companies, XREL Semi and Relchip have provided parts for Sandia evaluation. Tests will continue with more FastCAP parts.	Ongoing
FY(15) Present results at relevant conferences	Results of the three capacitor tests and the HT Flash evaluation will be presented at HiTEN 2015.	07/2015 Scheduled

# Future Directions

Milestone	Status & Expected Completion Date
- Results of four commercial off the shelf components will be presented at the High Temperature Electronics Network	On-Track 7/15
- The RelChip Silicon-On-Insulator RAM modules will be tested at 300C with the new Rogers 3000 PCBs.	On-Track 9/30/15
- Evaluation plan will be developed and tests will commence of more components from FastCAP Systems	On-Track 9/30/15
- In FY16, Tests of important components will continue to be conducted and the results shared publicly through the GDR and presentations/publications.	9/30/16

- High temperature tool developers suffer from a lack of components rated for geothermal temperatures.
- This project evaluates components to determine their suitability for use in high temperature geothermal tools.
- This project is assisting component developers with evaluation of new parts with high potential utility in geothermal tools.
- Evaluations are performed of commercial components beyond manufacturer temperature specifications to inform tool designers of expected performance.